

<b>PCN Number:</b>	20190820003	<b>PCN Date:</b>	Aug. 27, 2019
<b>Title:</b>	Datasheet for TLV702-Q1		
<b>Customer Contact:</b>	PCN Manager	<b>Dept:</b>	Quality Services
<b>Change Type:</b>			
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design
<input type="checkbox"/>	Assembly Process	<input checked="" type="checkbox"/>	Data Sheet
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change
<input type="checkbox"/>	Mechanical Specification	<input type="checkbox"/>	Test Site
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Material
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Bump Process
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Site
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Materials
<input type="checkbox"/>		<input type="checkbox"/>	Wafer Fab Process

### Notification Details

#### Description of Change:

Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.



**TLV702-Q1**

SLVSC35D – AUGUST 2013 – REVISED JULY 2019

#### Changes from Revision C (January 2018) to Revision D

**Page**

- |                                                                                        |   |
|----------------------------------------------------------------------------------------|---|
| • Changed OUT pin number from 5 to 3 in DSE column of <i>Pin Functions</i> table ..... | 4 |
| • Added footnote to maximum EN voltage specification .....                             | 5 |
| • Added parameter names to <i>Recommended Operating Conditions</i> table.....          | 5 |

The datasheet number will be changing.

Device Family	Change From:	Change To:
TLV702-Q1	SLVSC35C	SLVSC35D

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/TLV702-Q1>

#### Reason for Change:

To accurately reflect device characteristics.

#### Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

#### Changes to product identification resulting from this PCN:

None.

#### Product Affected:

TLV702125QDBVRQ1	TLV70218QDSERQ1	TLV70228QDDCRQ1	TLV70231QDSERQ1
TLV70212QDBVRQ1	TLV70225QDSERQ1	TLV70228QDSERQ1	TLV70232QDSERQ1
TLV70212QDSERQ1	TLV70227QDBVRQ1	TLV70229QDBVRQ1	TLV70233QDBVRQ1
TLV70213QDSERQ1	TLV70227QDSERQ1	TLV70229QDSERQ1	TLV70233QDSERQ1
TLV70215QDBVRQ1	TLV702285QDSERQ1	TLV70230QDBVRQ1	TLV70236QDSERQ1
TLV70215QDSERQ1	TLV70228QDBVRQ1	TLV70230QDSERQ1	TLV70245QDSERQ1
TLV70218QDBVRQ1			

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

<b>Location</b>	<b>E-Mail</b>
USA	<a href="mailto:PCNAmericasContact@list.ti.com">PCNAmericasContact@list.ti.com</a>
Europe	<a href="mailto:PCNEuropeContact@list.ti.com">PCNEuropeContact@list.ti.com</a>
Asia Pacific	<a href="mailto:PCNAsiaContact@list.ti.com">PCNAsiaContact@list.ti.com</a>
WW PCN Team	<a href="mailto:PCN_ww_admin_team@list.ti.com">PCN_ww_admin_team@list.ti.com</a>

## **IMPORTANT NOTICE AND DISCLAIMER**

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES “AS IS” AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale ([www.ti.com/legal/termsofsale.html](http://www.ti.com/legal/termsofsale.html)) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.